

MLP 3.3x3.3



Symbol	Parameter		Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage		100	V		
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		16		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		12	^	
Ъ	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	3.3	Α	
	-Pulsed		15			
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	32	mJ	
D	Power Dissipation	T <sub>C</sub> = 25 °C		35	14/	
P <sub>D</sub>	Power Dissipation $T_A = 25 \text{ °C}$ (Note 1a)			2.3	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to + 150	°C	

### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.5	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 53	C/vv

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC3612	FDMC3612	Power 33	13"	12 mm	3000 units

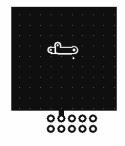
FDMC3612 N-Channel PowerTrench<sup>®</sup> MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		109		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2.0	2.5	4.0	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-7		mV/°0
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.3 A		92	110	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 3.0 A		98	122	mΩ
		$V_{GS} = 10 \text{ V}, \ I_D = 3.3 \text{ A}, \ T_J = 125 \text{ °C}$		177	212	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.3 A		13		S
Dynamic C <sub>iss</sub>	Characteristics			662	880	pF
C <sub>oss</sub>	Output Capacitance	$-V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		40	55	pr
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		23	35	pr
R <sub>g</sub>	Gate Resistance			1.3	00	Ω
						1
	J Characteristics			7.4	15	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 3.3 A,		2.8	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		19	34	ns
<u>t</u> f	Fall Time			2	10	ns
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		14.4	21	nC
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 50 V,$ $I_{D} = 3.3 \text{ A}$		7.9	12	nC
$Q_{gs}$	Total Gate Charge			2.3		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			3.7		nC
*	-					
Jrain-Sol	Irce Diode Characteristics	$V_{GS} = 0 V, I_S = 3.3 A$ (Note 2)		0.88	1.2	
	Course to Drain Diade, Forward Valtage					

¥	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 3.3 A$	(Note 2)	0.88	1.2	V
V <sub>SD</sub>	Source to Drain Diode Porward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)	0.77	1.2	v
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 3.3 A, di/dt = 100 A/μs		34	55	ns
Q <sub>rr</sub>	Reverse Recovery Charge			37	60	nC

NOTES:

1.  $R_{0,L}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{0,LC}$  is guaranteed by design while  $R_{0,CA}$  is determined by the user's board design.



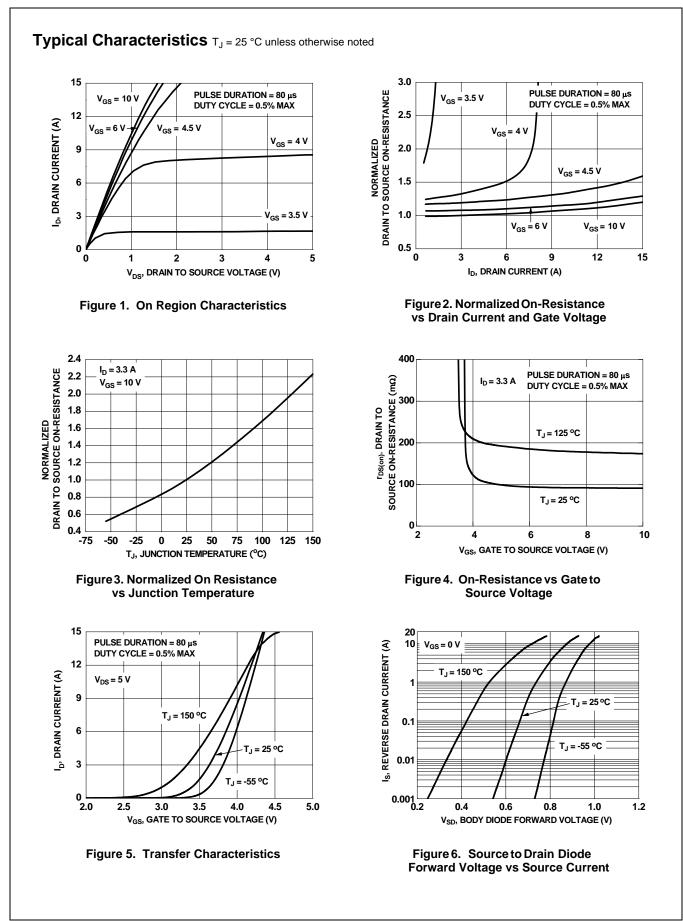
a) 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



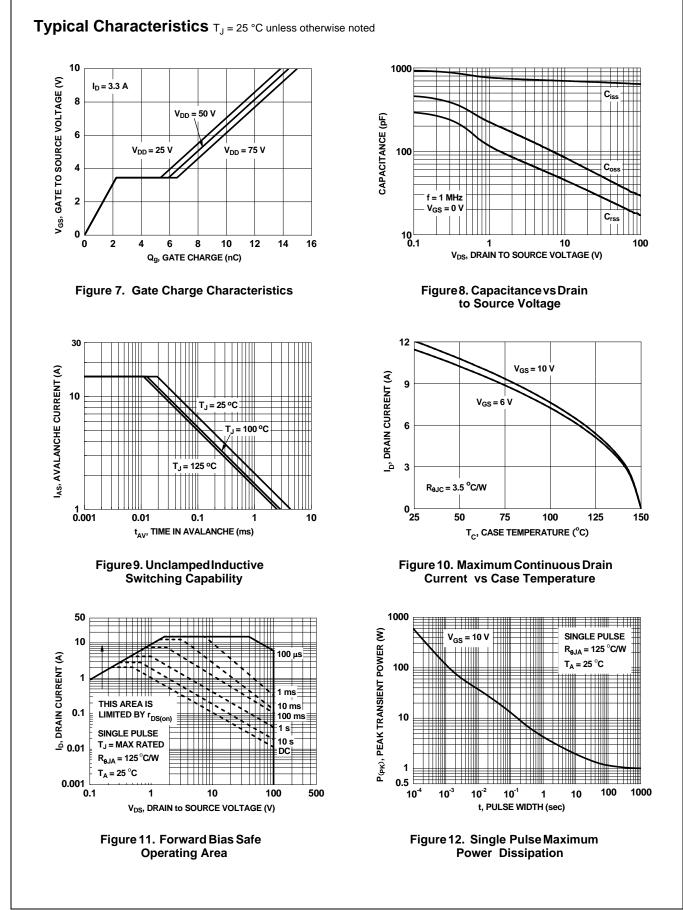
b) 125 °C/W when mounted on a minimum pad of 2 oz copper

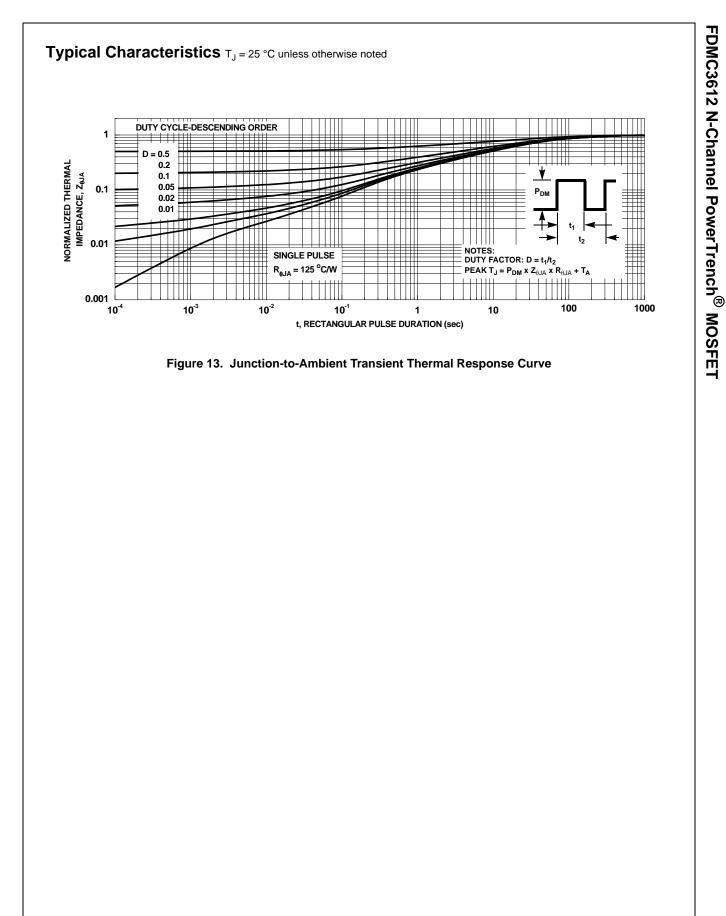
2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

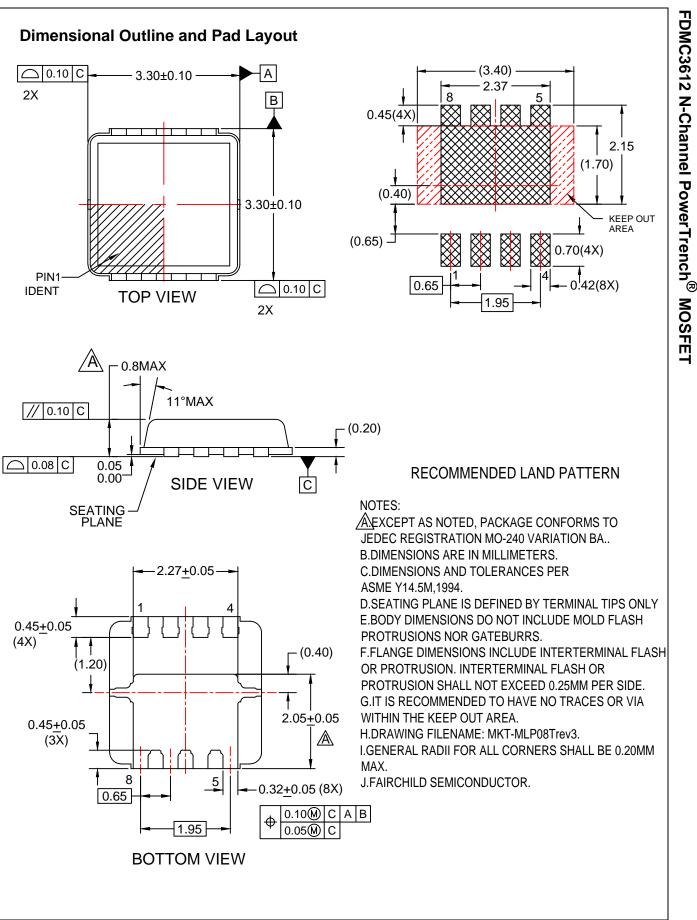
3. Starting T<sub>J</sub> = 25 °C; N-ch: L = 1 mH, I<sub>AS</sub> = 8 A, V<sub>DD</sub> = 90 V, V<sub>GS</sub> = 10 V.











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